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WINSTAR Display

OLED SPECIFICATION

Model No:

WEN025664AWPP3D00000

SPECIFICATION Version: E

CUSTOMER : MODULE NO. : WEN025664AWPP3D00000

APPROVED BY:

(FOR CUSTOMER USE ONLY)

SALES BY	APPROVED BY CHECKED BY	PREPARED BY
	R	
RELEASE DATE:		

APPROVAL FOR SPECIFICATIONS ONLY

APPROVAL FOR SPECIFICATIONS AND SAMPLE

MODEL NO:

REC	ORDS OF REV	/ISION	DOC. FIRST ISSUE
VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2021/05/20		First release
A	2021/10/27		Modify OLED Lifetime Conditions Description
В	2022/10/05		Modify Reliability Test and measurement conditions
С	2023/04/26		Modify Lifetime note
D	2023/05/18	Ś	Modify the inspection criteria name of the inspection specification
E	2023/09/01	N	Module classification code 10 modify CTP Laminate bonding description

Contents

- 1.Module Classification Information
- 2.General Specification
- 3.Contour Drawing & Block Diagram
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- 7. Optical Characteristics
- **8.OLED** Lifetime
- 9.Reliability
- 10.Inspection specification
- 11.Precautions in use of OLED Modules

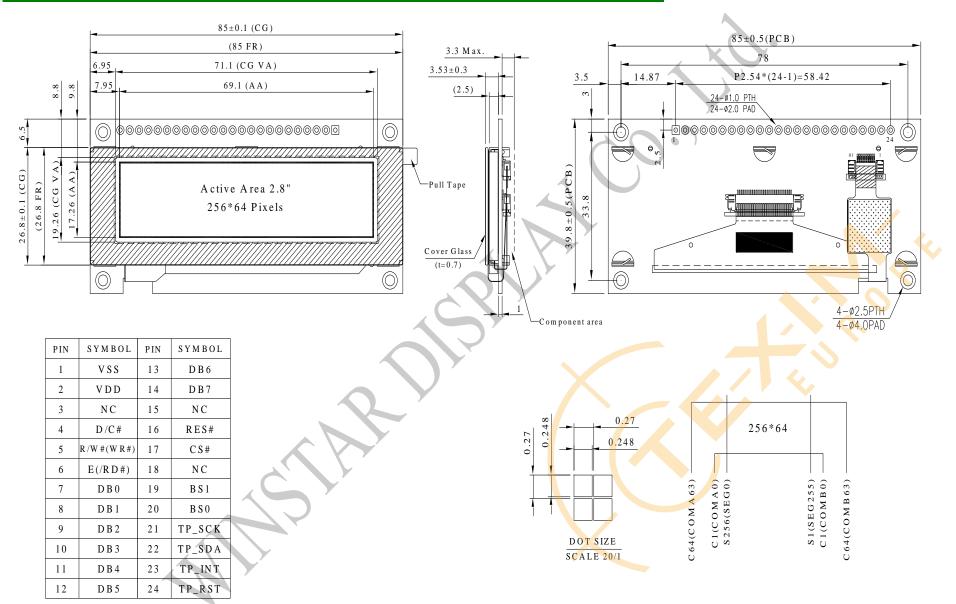


1	Brand : WINSTAR DISPLAY CORPORATION					
2	E : OLED					
		H : COB Character	G : COB Graphic			
0		O : COG	F : COG + FR	X CY		
3	Display Type	P : COG + FR + PCB	X : COF			
		A : COG + PCB	N : COF + FR + PCB	Y		
4	Dot Matrix : 28	56 * 64				
5	Serials code		$C \mathcal{O}$			
		A : Amber	R : Red	C : Full Color		
6	Emitting Color	B : Blue	W:White			
Ø		G : Green	L : Yellow			
		S : Sky Blue	X : Dual Color			
7	Polarizer	P: With Polarizer; N: Without Polarizer				
'		A : Anti-glare Polarizer				
8	Display Mode					
9	Driver Voltage	3:3.0~3.3V;5:5	3:3.0~3.3V;5:5.0V			
10	Touch Panel	N:Without touch panel; T:Resistive TP; D:CTP (Air bonding)				
		0 : Standard				
		1 : Daylight Readable				
11	Product type	2 : Transparent OLED				
		3 : Flexible OLED (FO	LED)			
		4 : OLED Lighting				
		0 : Standard		~		
12	Inspection	2 : Special grade		•		
	Grade	C : Automotive grade				
		Y : Consumer grade				
13	Option		Kit ; E~P : Op <mark>t</mark> ions ; Z : S	Semi-customized		
14	Serial No.	Serial number(00~99)				

2.General Specification

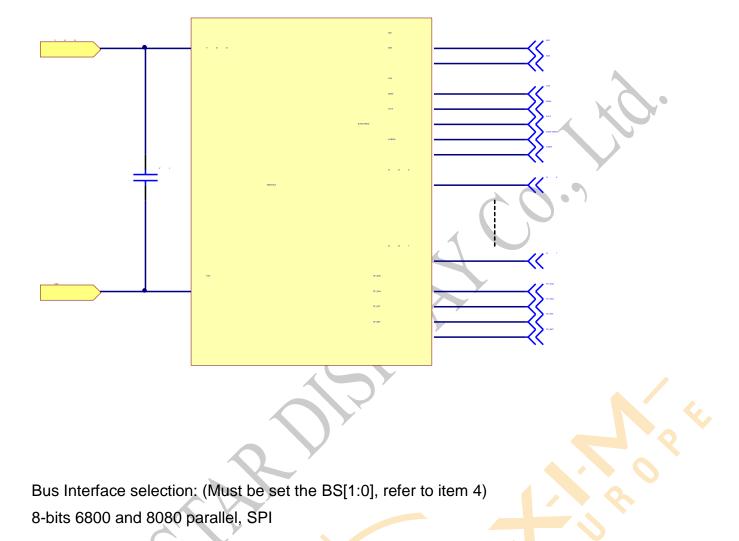
Item	Dimension	Unit
Dot Matrix	256 x 64 Dots	_
Module dimension	85.0 x 39.8 x 7.83	mm
Active Area	69.1 x 17.26	mm
Pixel Size	0.248 x 0.248	mm
Pixel Pitch	0.27 x 0.27	mm
Display Mode	Passive Matrix	0.
Display Color	White	
Drive Duty	1/64 Duty	
OLED IC	SSD1322 (COF)	
OLED Interface	6800, 8080, SPI	
Size	2.8 inch	
CTP IC	FT6336U	
Detect Point	1	
CTP Interface	I2C	
Surface	Normal Glare	
AIT		

3. Contour Drawing & Block Diagram



The non-specified tolerance of dimension is $\pm 0.3\mbox{ mm}$.

3.1 Application recommendations



C1: 1.0 μ F

Note: The capacitor value is recommended value. Select appropriate value against module application.

4.Interface Pin Function

Pin Number	Symbol	I/O	Function
1	VSS	Р	Ground.
2	VDD	Р	Power Supply for Core Logic Circuit Power supply pin for core logic operation. A capacitor is required to connect between this pin and VSS
3	N.C.	Р	Reserved Pin The N.C. pin between function pins are reserved for compatible and flexible design.
4	D/C#	Ι	Data/Command Control This pin is Data/Command control pin connecting to the MCU. When the pin is pulled HIGH, the content at D[7:0] will be interpreted as data. When the pin is pulled LOW, the content at D[7:0] will be interpreted as command.
5	R/W# (WR#)	Ι	Read/Write Select or Write This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as Read/Write (R/W#) selection input. Pull this pin to "High" for read mode and pull it to "Low" for write mode. When 80XX interface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled low and the CS# is pulled low. When serial mode is selected, this pin must be connected to VSS.
6	E/RD#	I	Read/Write Enable or Read This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled high and the CS# is pulled low. When connecting to an 80XX-microprocessor, this pin receives the Read (RD#) signal. Data read operation is initiated when this pin is pulled low and CS# is pulled low. When serial mode is selected, this pin must be connected to VSS.
7~14	DB0 DB1 DB2 DB3 DB4 DB5 DB6 DB7	I/O	Host Data Input/Output Bus These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK.
15	NC	Р	Reserved Pin The N.C. pin between function pins are reserved for compatible and flexible design.

	[
16	RES#	Ι	This pin is reset signal input. When the pin is pulled LOW, initialization of the chip is executed. Keep this pin pull HIGH during normal operation.		
17	CS#	Ι	Data/Command Control This pin is the chip select input connecting to the MCU. The chip is enabled for MCU communication only when CS# is pulled LOW.		
18	NC	Р	Reserved Pin The N.C. pin between function pins are reserved for compatible and exible design.		
19	BS1		Communicating Protocol Select		
20	BS0	Ι	Bs[1:0] Bus Interface Selection 00 4 line SPI 01 3 line SPI 10 8-bit 8080 parallel 11 8-bit 6800 parallel Note (1) 0 is connected to VSS (2) 1 is connected to VDD		
21	TP_SCK	Ι	I2C clock input		
22	TP_SDA	Ι	I2C data input and output		
23	TP_INT	Ι	External interrupt to the host		
24	TP_RST	Ι	External Reset, Low is active		

5.Absolute Maximum Ratings

5.1 Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Display	VDD	-0.3	4	V	1, 2
Operating Temperature	TOP	-20	70	°C	-
Storage Temperature	TSTG	-30	80	°C	-

Note 1: All the above voltages are on the basis of "VSS = 0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 6 "Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate

6.Electrical Characteristics

6.1 DC Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Logic	VDD	_	2.8	3.0	3.3	V
High Level Input	VIH	_	0.8×VDD		VDD	V
Low Level Input	VIL	_	0		0.2×VDD	V
High Level Output	VOH	_	0.9×VDD	C	VDD	V
Low Level Output	VOL		0		0.1×VDD	V
50% Check Board operating Current	IDD	VDD =3V		125	250	mA

6.2 OLED DISPLAY's Initial code

	Initial_ic(void)	
{	write_command(0xFD); write_data(0x12);	//set Command Lock
	write_command(0xAE);	//Sleep mode ON (Display OFF)
	write_command(0xB4); write_data(0xA2); write_data(0xB5);	//Display Enhancement A // Internal VSL
	write_command(0xA0); write_data(0x10); write_data(0x11);	//set Re-map and Dual COM Line mode
	write_command(0xCA); write_data(0x3F);	//set MUX Ratio
	write_command(0xD1); write_data(0x82); write_data(0x20);	//Display Enhancement B
	write_command(0xC1); write_data(0XC0);	//set Contrast current
	write_command(0xC7); write_data(0x0F);	//master Contrast current Control
	write_command(0xB3); write_data(0x61);	//set Front Clock Divider/Oscillator Frequency //105Hz
	write_command(0xB1); write_data(0XF5);	//set Phase Length
	write_command(0xBB); write_data(0x1F);	//set pre-charge voltage
	write_command(0xBE); write_data(0x07);	//set VCOMH
	write_command(0xB6); write_data(0x0F);	//set Current Pre-charge Period
	write_command(0xB9);	// Selec <mark>t</mark> Default Linear Gray Scale table
	write_command(0xAB); write_data(0x01);	//Function Selection
	write_command(0x00);	// Enable Gray Scale Table
	write_command(0xA1); write_data(0x00);	//set Display Start Line
	write_command(0xA2);	//set Display Offset
	WINSTAR	WEN025664AWPP3D00000 第11頁,共29頁

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write_data(0x00);

}

write_command(0xA6);	//set Display Mode
write_command(0x15); write_data(0x1C); write_data(0x5B);	//set Column Address
write_command(0x75); write_data(0x00); write_data(0x3F);	//set Row Address
write_command(0x5C);	//Write RAM Command
write_command(0xAF);	//Sleep mode OFF (Display ON)

Note1: Initial code is for reference only. Please make the best adjustment with the OLED module. Note2: Command: Set Contrast Control (0xC1), This command sets the Contrast Setting of the display. The chip has 256 contrast steps from 00h to FFh. The segment output current increases as the contrast step value increases. The segment current increases, the OLED brightness increases.

WINSTAR

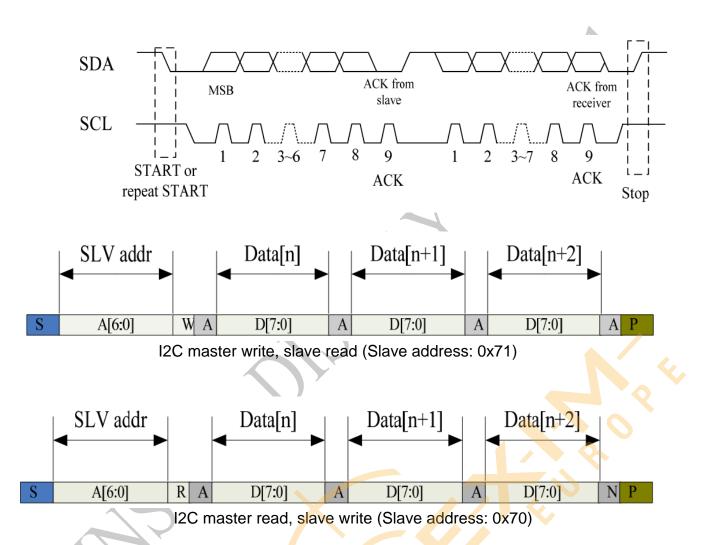
6.3 TOUCH PANEL's application code.

6.3.1 I2C address format

I2C slave addresses: 0x70

6.3.2 I2C Read/Write Interface description

The I2C is always configured in the Slave mode.



Mnemonics Description

Mnemonics	Description
S	I2C Start or I2C Restart
A[6:0]	Slave address
R/W	READ/WRITE bit, '1' for read, '0' for write
A(N)	ACK(NACK)
Р	STOP: the indication of the end of a packet (if this bit is missing, S will indicate the end of the current packet and the beginning of the next packet)

Timing Characteristics

Parameter	Min	Max	Unit
SCL frequency	10	400	KHz
Bus free time between a STOP and START condition	4.7	\	us
Hold time (repeated) START condition	4.0	\	us
Data setup time	250	\	ns
Setup time for a repeated START condition	4.7	\	us
Setup Time for STOP condition	4.0	\	us

6.3.3 Coordinates Information

Address	Name	Default Value	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Host Access
0x02	TD_STATUS	0x00					points			ıch	R
0x03	P1_XH	0xFF	[7:6]1 Event					1 st Touc sition[1			R
0x04	P1_XL	0xFF	[7:0] 1 st Touch X Position			R					
0x05	P1_YH	0xFF	[7:4]	1 st Touc	h ID			1 st Touc ition[1]			R
0x06	P1_YL	0xFF	[7:0]	1 st Touc	h Y Po	sition					R

TD_STATUS

This register is the Touch Data status register.

Address	Bit Address	Register Name	Description	
002	3:0	Number of touch points [3:0]	The detected point number, 1-2 is valid.	
0x02	7:4	Reserved		Þ

P1_XH

This register describes MSB of the X coordinate of the nth touch point and the corresponding event flag.

Address	Bit Address	Register Name	Description
0x03	7:6	Event Flag	00b: Press Down 01b: Lift Up
			10b: Contact
			11b: No event
	5:4		Reserved
	3:0	Touch X Position [11:8]	MSB of Touch X Position in pixels

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P1_XL

This register describes LSB of the X coordinate of the nth touch point.

6			1
Address	Bit Address	Register Name	Description
0x04	7:0	Touch X Position [7:0]	LSB of the Touch X Position in pixels
· · · · · ·			

P1_YH

This register describes MSB of the Y coordinate of the nth touch point and corresponding touch ID.

Address	Bit Address	Register Name	Description
0x05	7:4	Touch ID[3:0]	Touch ID of Touch Point, this value is 0x0F when the ID is invalid
2	3:0	Touch Y Position [11:8]	MSB of Touch Y Position in pixels

P1_YL

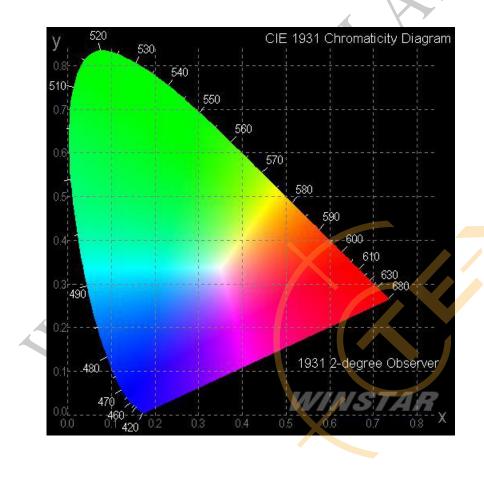
This register describes LSB of the Y coordinate of the nth touch point.

Address	Bit Address	Register Name	Description
0x06			
	7:0	Touch Y Position [7:0]	LSB of the Touch Y Position in pixels

Note: X-Y Resolutions: 256 x 64

7.Optical Characteristics

ltem	Symbol	Condition	Min	Тур	Max	Unit
	(V)θ	_	160	—	_	deg
View Angle	(H)φ	_	160	_	1	deg
Contrast Ratio	CR	Dark	10,000:1	_	X	•
Deeren on Time	T rise	_	_	10	2	μs
Response Time	T fall	_	_	10		μs
Display with 50%	% check Bo	oard Brightness	60	80	_	cd/m2
CIEx(White) (CIE1931)			0.26	0.28	0.30	—
CIEy(White)		(CIE1931)	0.30	0.32	0.34	_



8.OLED Lifetime

ITEM	Conditions	Min	Тур	Remark
Operating Life Time	Ta=25°C / Initial 50% checkerboard brightness Typical Value	20,000 Hrs	_	Note

Note:

- Lifetime is defined the amount of time when the luminance has decayed to <50% of the minimal brightness.
- 2. This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (*pdf*) for the product under normal use conditions.
- 3. Screen saving mode will extend OLED lifetime.
- 4. Lifetime is not guaranteed one but expected lifetime in normal condition.

9.Reliability

Content of Reliability Test

Test Item	Content of Test	Test Condition	Applicable Standard
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 240hrs	
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 240hrs	
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 240hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 240hrs	
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60°C,90%RH 240hrs	
High Temperature/ Humidity Operation	Endurance test applying the high temperature and high humidity Operation for a long time.	60°C,90%RH 120hrs	
Temperature Cycle	Endurance test applying the low and high temperature cycle. -30°C 25°C 80°C 30min 5min 30min 1 cycle	-30°C /80°C 30 cycles	
Mechanical Te	st		
Vibration test	Endurance test applying the vibration during transportation and using.	Frequency:10~55Hz amplitude:1.5mm Time:0.5hrs/axis Test axis:X,Y,Z	
Others			
Static electricity test	Endurance test applying the electric stress to the finished product housing.	Air Discharge model ±4kv,10 times	

*** Supply voltage for OLED system =Operating voltage at 25° C

Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the functional test at 23±5°C; 55±15% RH.
- 2. All-pixels on/off exchange is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for High Temperature storage, High Temperature/ Humidity Storage, Temperature Cycle.
- 4. No Condensation.

Evaluation criteria

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within \pm 50% of initial value.

APPENDIX:

RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.

10.Inspection specification

Inspection Standard:

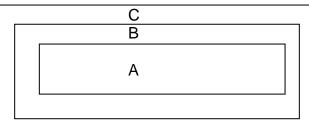
MIL-STD-105E table normal inspection single sample level II.

Definition

1 Major defect : The defect that greatly affect the usability of product.

2 Minor defect : The other defects, such as cosmetic defects, etc.

Definition of inspection zone:



Zone A: Active Area

Zone B: Viewing Area except Zone A

Zone C: Outside Viewing Area

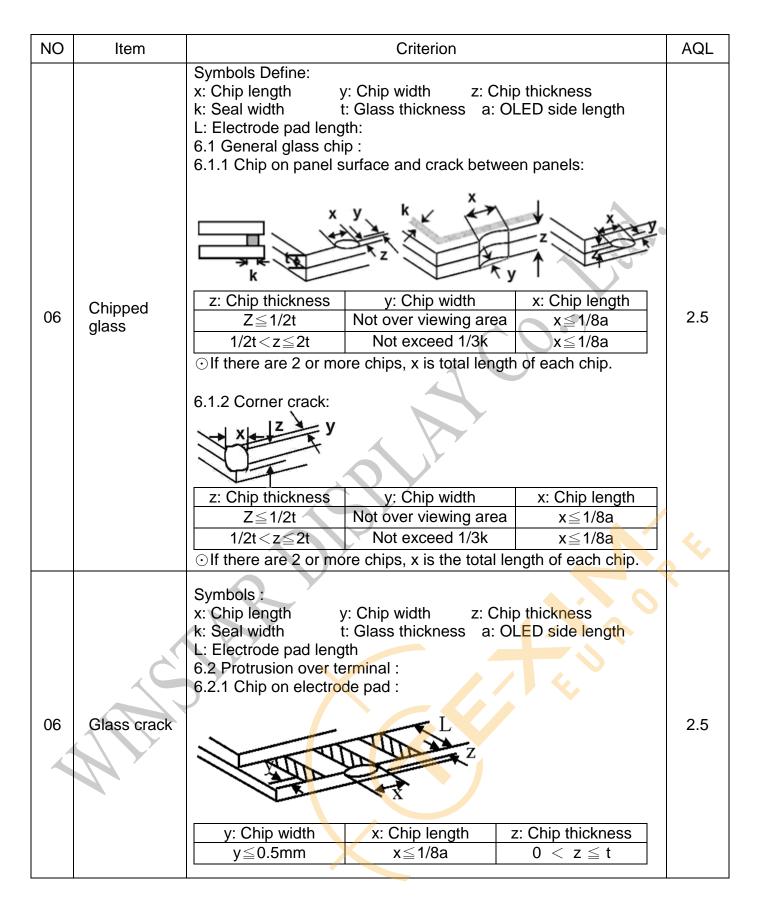
Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble of quality and assembly to customer's product.

Inspection Methods

- 1 The general inspection : Under fluorescent light illumination: 750~1500 Lux, about 30cm viewing distance, within 45° viewing angle, under 25±5°C.
- 2 The luminance and color coordinate inspection : By SR-3 or BM-7 or the equal equipments, in the dark room, under 25±5°C.

NO	Item	Criterion	AQL
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 OLED viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 	0.65
02	Black or white spots on OLED (display only)	 2.1 White and black spots on display ≤ 0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm. 	2.5

NO	Item		Criterion			AQL
	OLED black spots, white spots, contaminati on (non- display)	3.1 Round type : As following drawing $\Phi=(x + y)/2$	SIZE Φ≦0.10 0.10<Φ≦0.20 0.20<Φ≦0.25 0.25<Φ	Acceptable QTY ignore 2 1 0	Zone A+ B A+ B A+ B A+ B	2.5
03		3.2 Line type : (As	Width W≦0.02 0.02 < W ≤ 0.03	Acceptable Q TY ignore	Zone A+B A+B A+B	2.5
04	Polarizer bubbles /Dent	 4.1 If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction. 4.2 The polarizer d 	Size Φ $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total Q TY ent follows this speced.	Acceptable Q TY ignore 3 2 0 3 3 ecification.	Zone A+B A+B A+B A+B	2.5
05	Scratches	Follow NO.3 OLED	black spots, white	e spots, contamina	tion.	

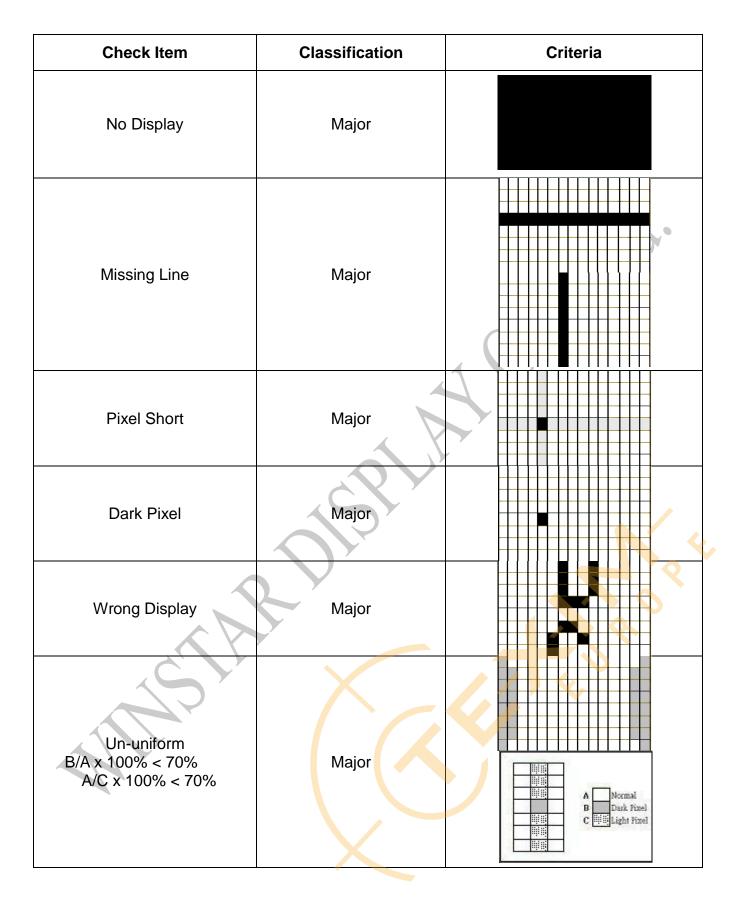


NO	Item	Criterion		
06	Glass crack	6.2.2 Non-conductive portion: $\begin{array}{c c c c c c c c c c c c c c c c c c c $	2.5	
07	Cracked glass	The OLED with extensive crack is not acceptable.	2.5	
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards. 	0.65	
09	Bezel	 8.3 Backlight doesn't light or color wrong. 9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination. 	0.65	
		 9.2 Bezel must comply with job specifications. 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 	0.65 2.5 2.5 0.65	
10	PCB , COB	 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or 	2.5 2.5 0.65 0.65 2.5	

screw hold pad, make sure it is smoothed down.		screw hold pad, make sure it is smoothed down.	
--	--	--	--



NO	Item	Criterion	AQL
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65
12	General appearance	 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet. 12.9 OLED pin loose or missing pins. 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product specification sheet. 	2.5 0.65 2.5 2.5 2.5 2.5 2.5 0.65 0.65 0.65



11.Precautions in use of OLED Modules

Modules

- (1) Avoid applying excessive shocks to module or making any alterations or modifications to it.
- (2) Don't make extra holes on the printed circuit board, change the components or modify its shape of OLED display module.
- (3) Don't disassemble the OLED display module.
- (4) Do not apply input signals while the logic power is off.
- (5) Don't operate it above the absolute maximum rating.
- (6) Don't drop, bend or twist OLED display module.
- (7) Soldering: only to the I/O terminals.
- (8) Hot-Bar FPC soldering condition: 280~350C, less than 5 seconds.
- (9) Winstar has the right to change the passive components (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.) and change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) Winstar has the right to upgrade or modify the product function.
- (11) For COG & COF structure OLED products, customers should reserve VCC (VPP) adjustment function or software update function when designing OLED supporting circuit. (The progress of OLED light-emitting materials will increase the conversion efficiency and the brightness. The brightness can be adjusted if necessary).

11.1. Handling Precautions

- (1) Since the display panel is being made of glass, do not apply mechanical impacts such as dropping from a high position.
- (2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- (3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged. So, be careful not to apply pressure to these sections.
- (4) The polarizer covering the surface of the OLED display module is soft and easily scratched.
- (5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage by using following adhesion tape.

* Scotch Mending Tape No. 810 or an equivalent

Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.

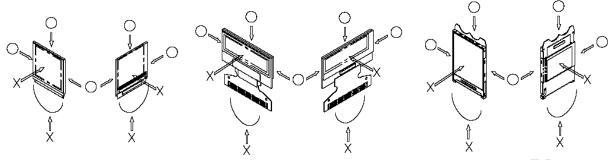
Also, pay attention that the following liquid and solvent may spoil the polarizer:

* Water

- * Ketone
- * Aromatic Solvents
- (6) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5.
- (7) Do not touch the following sections whenever possible while handling the OLED display modules.
 - * Pins and electrodes

* Pattern layouts such as the TCP & FPC

(8) Hold OLED display module very carefully when placing OLED display module into the System housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



- (9) Do not apply stress to the LSI chips and the surrounding molded sections.
- (10) Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity.

* Be sure to make human body grounding when handling OLED display modules.

* Be sure to ground tools to use or assembly such as soldering irons.

* To suppress generation of static electricity, avoid carrying out assembly work under dry environments.

* Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.

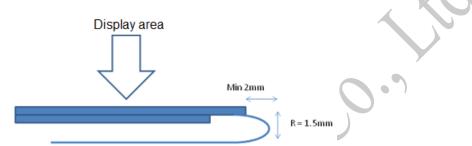
11.2. Storage Precautions

- (1) When storing OLED display modules, put them in static electricity preventive bags to avoid be directly exposed to sun or lights of fluorescent lamps. And, also, place in the temperature 25±5°C and Humidity below 65% RH.(We recommend you to store these modules in the packaged state when they were shipped from Winstar. At that time, be careful not to let water drops adhere to the packages or bags.)
- (2) When the OLED display module is being dewed or when it is placed under high temperature or high humidity environments, the electrodes may be corroded if electric current is applied. Please store it in clean environment.

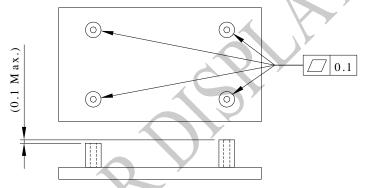
11.3. Designing Precautions

- (1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, OLED display module may be damaged.
- (2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specification and to make the signal line cable as short as possible.
- (3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD / VCC). (Recommend value: 0.5A)
- (4) Pay sufficient attention to avoid occurrence of mutual noise interference with the nearby devices.
- (5) As for EMI, take necessary measures on the equipment side basically.
- (6) If the power supplied to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.
 - * Connection (contact) to any other potential than the above may lead to rupture of the IC.

- (7) If this OLED driver is exposed to light, malfunctioning may occur and semiconductor elements may change their characteristics.
- (8) The internal status may be changed, if excessive external noise enters into the module. Therefore, it is necessary to take appropriate measures to suppress noise generation or to protect module from influences of noise on the system design.
- (9) We recommend you to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.
- (10) It's pretty common to use "Screen Saver" to extend the lifetime and Don't use the same image for long time in real application. When an OLED display module is operated for a long of time with fixed pattern, an afterimage or slight contrast deviation may occur.
- (11) The limitation of FPC and Film bending.



(12) The module should be fixed balanced into the housing, or the module may be twisted.



(13) Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

11.4. Precautions when disposing of the OLED display modules

(1) Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

Disclaimer

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